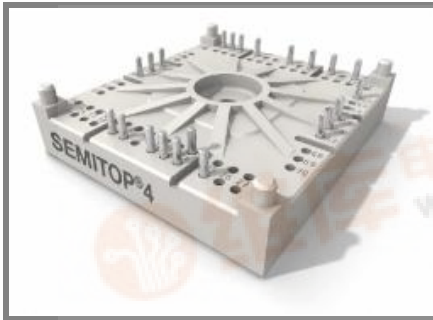


SK 50 GD 126 T



SEMITOP® 4

3-phase bridge inverter

SK 50 GD 126 T

Target Data

Features

- One screw mounting module
- Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

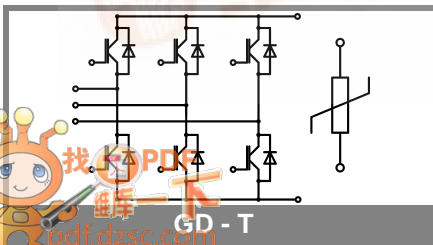
Typical Applications

- Inverter up to 28 kVA
- Typ. motor power 15 kW

1) $V_{CE,sat}$, V_F = chip level value

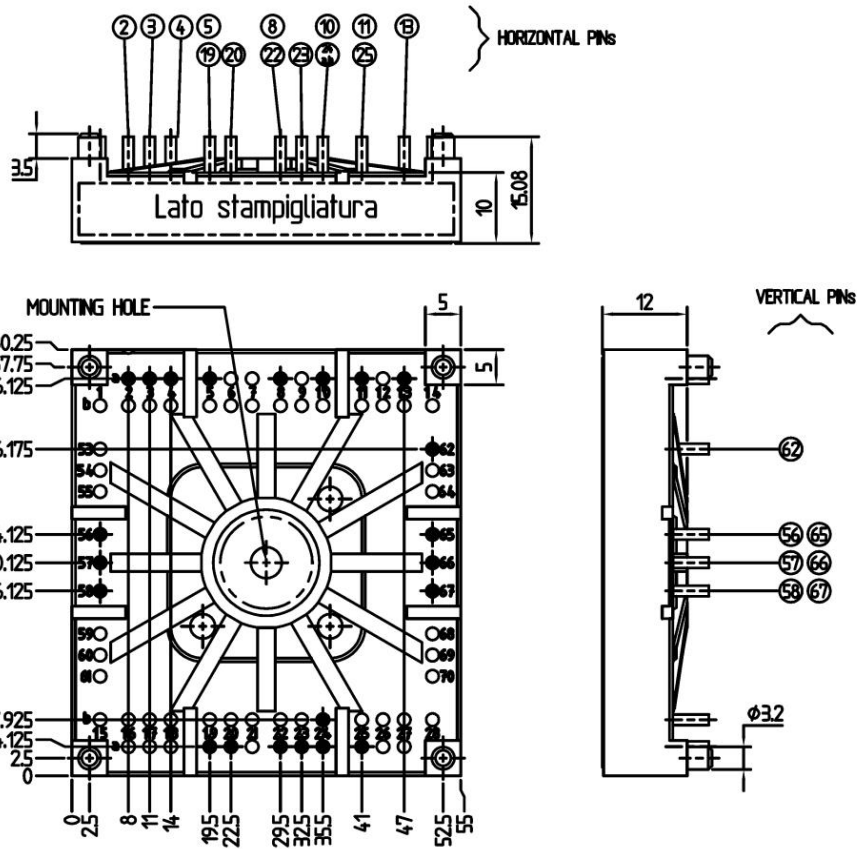
Absolute Maximum Ratings		Ts = 25 °C, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Inverter			
V_{CES}	$T_s = 25 (70) ^\circ C$ $t_p = 1 ms$	1200	V
I_C		68 (52)	A
I_{CRM}		136	A
V_{GES}		± 20	V
T_j		-40 ... +150	$^\circ C$
Diode - Inverter			
I_F	$T_s = 25 (70) ^\circ C$	62 (46)	A
I_{FRM}	$I_{FRM} = 2xI_{Fnom}, t_p = 1 ms$	124	A
T_j		-40 ... +150	$^\circ C$
Rectifier			
V_{RRM}	$T_s = ^\circ C$ $t_p = ms, \sin ^\circ, T_j = ^\circ C$ $t_p = ms, \sin ^\circ, T_j = ^\circ C$		V
I_F			A
I_{FSM} / I_{TSM}			A
I_t^2			A ² s
T_j		-40 ... +150	$^\circ C$
T_{sol}	Terminals, 10 s	260	$^\circ C$
T_{stg}		-40 ... +125	$^\circ C$
V_{isol}	AC, 1 min. / 1 s	2500 / 3000	V

Characteristics		Ts = 25 °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Inverter					
V_{CEsat}	$I_C = 50 A, T_j = 25 (125) ^\circ C$		1,7 (2)	2,15 (2,45)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 2 mA$	5	5,8	6,5	V
$V_{CE(TO)}$	$T_j = 25 ^\circ C (125) ^\circ C$		1 (0,9)	1,2 (1,1)	V
r_T	$T_j = 25 ^\circ C (125) ^\circ C$		14 (22)	19 (27)	m Ω
C_{ies}	$V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$		-	-	nF
C_{oes}	$V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$		-	-	nF
C_{res}	$V_{CE} = 25 V_{GE} = 0 V, f = 1 MHz$		-	-	nF
$R_{th(j-s)}$	per IGBT		0,6		K/W
$t_{d(on)}$	under following conditions		-	-	ns
t_r	$V_{CC} = 600 V, V_{GE} = \pm 15 V$		-	-	ns
$t_{d(off)}$	$I_C = 50 A, T_j = 125 ^\circ C$		-	-	ns
t_f	$R_{Gon} = R_{Goff} = 12 \Omega$		-	-	ns
E_{on}	inductive load		5,6		mJ
E_{off}			6,5		mJ
Diode - Inverter					
$V_F = V_{EC}$	$I_F = 50 A, T_j = 25 (125) ^\circ C$		1,35 (1,35)		V
$V_{(TO)}$	$T_j = 25 ^\circ C (125) ^\circ C$		0,95 (0,85)		V
r_T	$T_j = 25 ^\circ C (125) ^\circ C$		8 (10)		m Ω
$R_{th(j-s)}$	per diode		1		K/W
I_{RRM}	under following conditions		-		A
Q_{rr}	$I_F = A, V_R = V$		-		μC
E_{rr}	$V_{GE} = 0 V, T_j = 125 ^\circ C$ $di_F/dt = - A/\mu s$		-		mJ
Diode rectifier					
V_F	$I_F = A, T_j = 25 ^\circ C$				V
$V_{(TO)}$	$T_j = ^\circ C$				V
r_T	$T_j = ^\circ C$				m Ω
$R_{th(j-s)}$	per diode				K/W
Temperatur sensor					
R_{ts}	5 %, $T_r = 25 (100) ^\circ C$		5000(493)		Ω
Mechanical data					
w			60		g
M_s	Mounting torque		3,5		Nm

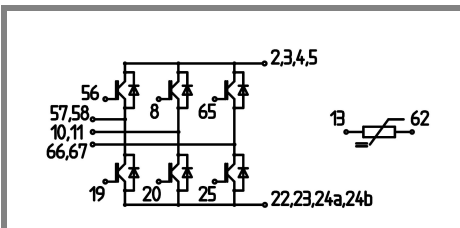


SK 50 GD 126 T

Dimensions in mm



Case T 74



Case T 74

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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